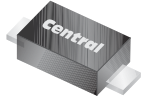


CMMR1 SERIES**SURFACE MOUNT SILICON
GENERAL PURPOSE RECTIFIERS
1 AMP, 200 THRU 1000 VOLT****SOD-123F CASE**www.centrasemi.com**DESCRIPTION:**

The CENTRAL SEMICONDUCTOR CMMR1 Series of High Current Density Rectifiers, in a SOD-123F surface mount package are designed for all types of commercial, industrial computer and automotive applications.

**MARKING CODE: SEE MARKING CODE TABLE
ON FOLLOWING PAGE****MAXIMUM RATINGS:** ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

	SYMBOL	CMMR1-02	CMMR1-04	CMMR1-06	CMMR1-10	UNITS
Peak Repetitive Reverse Voltage	V_{RRM}	200	400	600	1000	V
DC Blocking Voltage	V_R	200	400	600	1000	V
RMS Reverse Voltage	$V_{R(RMS)}$	140	280	420	700	V
Average Forward Current ($T_L=75^{\circ}\text{C}$)	I_O		1.0			A
Peak Forward Surge Current (8.3ms)	I_{FSM}		30			A
Operating and Storage Junction Temperature	T_J, T_{stg}		-65 to +150			$^{\circ}\text{C}$
Thermal resistance (Note 1)	θ_{JA}		180			$^{\circ}\text{C/W}$
Thermal resistance (Note 2)	θ_{JA}		65			$^{\circ}\text{C/W}$

ELECTRICAL CHARACTERISTICS: ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

SYMBOL	TEST CONDITIONS	TYP	MAX	UNITS
I_R	$V_R=\text{Rated } V_{RRM}$		10	μA
I_R	$V_R=\text{Rated } V_{RRM}, T_A=125^{\circ}\text{C}$		50	μA
V_F	$I_F=1.0\text{A}$		1.1	V
C_J	$V_R=4.0\text{V}, f=1.0\text{MHz}$	6.0		pF

Notes: (1) FR-4 Epoxy PCB with copper mounting pad area of 2.2mm^2
 (2) FR-4 Epoxy PCB with copper mounting pad area of 36mm^2

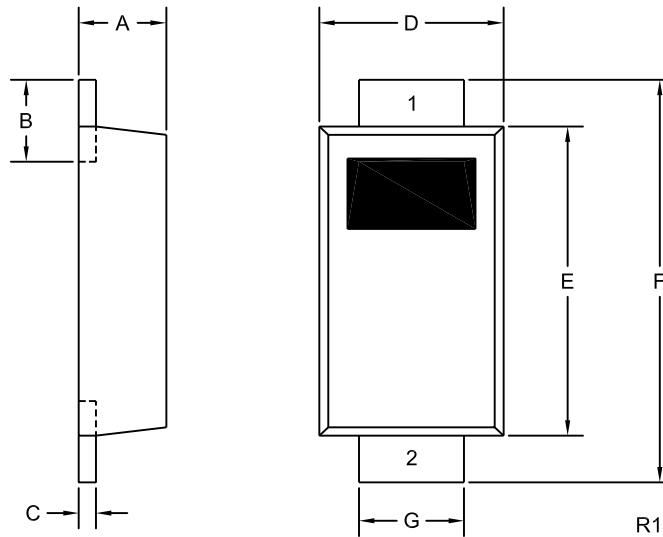
R3 (29-September 2014)

CMMR1 SERIES

SURFACE MOUNT SILICON
GENERAL PURPOSE RECTIFIERS
1 AMP, 200 THRU 1000 VOLT



SOD-123F CASE - MECHANICAL OUTLINE



DEVICE	MARKING CODE
CMMR1-02	C02F
CMMR1-04	C04F
CMMR1-06	C06F
CMMR1-10	C10F

LEAD CODE:

- 1) Cathode
- 2) Anode

DIMENSIONS				
SYMBOL	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.035	0.043	0.88	1.08
B	0.020	0.031	0.50	0.80
C	0.004	0.008	0.10	0.20
D	0.065	0.077	1.65	1.95
E	0.104	0.116	2.65	2.95
F	0.140	0.156	3.55	3.95
G	0.030	0.041	0.75	1.05

SOD-123F (REV:R1)

R3 (29-September 2014)

OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options
- Custom bar coding for shipments
- Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities
- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- Application and design sample kits
- Custom product and package development

REQUESTING PRODUCT PLATING

1. If requesting Tin/Lead plated devices, add the suffix " TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
2. If requesting Lead (Pb) Free plated devices, add the suffix " PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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